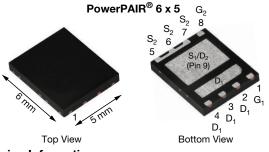
SiZ988DT



Dual N-Channel 30 V (D-S) MOSFETs

PRODUCT SUMMARY							
	V _{DS} (V)	R _{DS(on)} (Ω) (MAX.)	I _D (A)	Q _g (TYP.)			
Channel-1	30	0.0075 at V _{GS} = 10 V	40 ^g	6.9 nC			
	30	0.0120 at V _{GS} = 4.5 V 32	32 g	0.9110			
Channel-2	30	0.0041 at V _{GS} = 10 V	_{GS} = 10 V 60	15.4 nC			
Griannei-2	30	0.0052 at V_{GS} = 4.5 V	60	15.4 110			



Ordering Information:

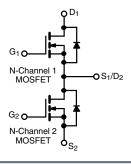
SiZ988DT-T1-GE3 (lead (Pb)-free and halogen-free)

FEATURES

- TrenchFET[®] Gen IV power MOSFETs
- 100 % R_g and UIS tested
- Optimized Q_{qs}/Q_{qs} ratio improves switching characteristics
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- CPU core power
- Computer / server peripherals
- POL
- Synchronous buck converter
- Telecom DC/DC



ABSOLUTE MAXIMUM RATINGS (T	$A = 25 ^{\circ}C$, unless	s otherwise n	oted)		
PARAMETER	SYMBOL	CHANNEL-1	CHANNEL-2	UNIT	
Drain-Source Voltage	V _{DS}	3	V		
Gate-Source Voltage	V _{GS}	+20			
	T _C = 25 °C		40 g	60 ^a	
Continuous Drain Current (T. 150 °C)	T _C = 70 °C	- I _D -	32 ^g	60 ^a	
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C		17.5 ^{b, c}	27 ^{b, c}	
	T _A = 70 °C		14 ^{b, c}	21.7 ^{b, c}	^
Pulsed Drain Current (t = 100 µs)	I _{DM}	70	140	A	
Continuous Course Durin Diado Current	T _C = 25 °C	- I _S	16.8	33.6	
Continuous Source Drain Diode Current	T _A = 25 °C		3.2 ^{b, c}	4 ^{b, c}	
Single Pulse Avalanche Current		I _{AS}	10	20	
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	5	20	mJ
	T _C = 25 °C		20.2	40	
Movimum Dower Dissinction	T _C = 70 °C		12.9	25.8	W
Maximum Power Dissipation	T _A = 25 °C	P _D	3.8 ^{b, c}	4.8 ^{b, c}	vv
	T _A = 70 °C	1	2.4 ^{b, c}	3.1 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150		°C
Soldering Recommendations (Peak Temperature) d, e		260		C

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	CHAN	NEL-1	CHAN	NEL-2	UNIT
PANAMETEN		STWIDOL	TYP.	MAX.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient b, f	t ≤ 10 s	R _{thJA}	26	33	21	26	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	4.7	6.2	2.5	3.1	0/10

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

- d. See solder profile (www.vishay.com/doc?73257). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is 68 °C/W for channel-1 and 57 °C/W for channel-2. f.

g. $T_C = 25 \ ^{\circ}C.$

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Document Number: 66937

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SiZ988DT

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SYMBOL V _{DS} V _{GS} (th) I _{GSS} I _{DSS}	$\begin{split} & V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A} \\ & V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A} \\ & V_{DS} = V_{GS}, \text{ I}_{D} = 250 \mu\text{A} \\ & V_{DS} = V_{GS}, \text{ I}_{D} = 250 \mu\text{A} \\ & V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}, -16 \text{ V} \\ & V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V} \\ & V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V} \end{split}$	Ch-1 Ch-2 Ch-1 Ch-2 Ch-1 Ch-2 Ch-1 Ch-2 Ch-1 Ch-2	30 30 1.2 1.1 - - - - -	- - - - - - - - - - - - -	- - 2.4 2.2 ± 100 ± 100 1 1	V V nA	
V _{GS(th)} -	$V_{GS} = 0 V, I_D = 250 \mu A$ $V_{DS} = V_{GS}, I_D = 250 \mu A$ $V_{DS} = V_{GS}, I_D = 250 \mu A$ $V_{DS} = 0 V, V_{GS} = \pm 20 V, -16 V$ $V_{DS} = 30 V, V_{GS} = 0 V$	Ch-2 Ch-1 Ch-2 Ch-1 Ch-2 Ch-1 Ch-2 Ch-1	30 1.2 1.1 - - - - -		2.2 ± 100 ± 100 1	v	
V _{GS(th)} -	$V_{GS} = 0 V, I_D = 250 \mu A$ $V_{DS} = V_{GS}, I_D = 250 \mu A$ $V_{DS} = V_{GS}, I_D = 250 \mu A$ $V_{DS} = 0 V, V_{GS} = \pm 20 V, -16 V$ $V_{DS} = 30 V, V_{GS} = 0 V$	Ch-1 Ch-2 Ch-1 Ch-2 Ch-1 Ch-2 Ch-2 Ch-1	1.2 1.1 - - - -	- - - -	2.2 ± 100 ± 100 1	v	
I _{GSS}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$ $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ $V_{DS} = 0 \ V, V_{GS} = \pm 20 \ V, -16 \ V$ $V_{DS} = 30 \ V, V_{GS} = 0 \ V$	Ch-2 Ch-1 Ch-2 Ch-1 Ch-2 Ch-2 Ch-1	1.1 - - - -	- - - -	2.2 ± 100 ± 100 1		
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V, -16 V$ $V_{DS} = 30 V, V_{GS} = 0 V$	Ch-1 Ch-2 Ch-1 Ch-2 Ch-1		-	± 100 ± 100 1		
I _{DSS} -	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	Ch-2 Ch-1 Ch-2 Ch-1	-	-	± 100 1	nA	
I _{DSS} -	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	Ch-1 Ch-2 Ch-1	-	-	1		
		Ch-2 Ch-1	-	-			
		Ch-1	-	-	1		
	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 $^{\circ}C$			-		μA	
I _{D(on)}	VDS = 55 V, VGS = 5 V, TJ = 55 C	Ch-2			10	μΛ	
I _{D(on)}		-	-	-	10		
'D(on)	$V_{DS} \ge 5 V$, $V_{GS} = 10 V$	Ch-1	25	-	-	А	
		Ch-2	25	-	-	~	
	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	Ch-1	-	0.0057	0.0075		
Broken	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 19 \text{ A}$	Ch-2	-	0.0028	0.0041	Ω	
US(on)	$V_{GS}=4.5~V,~I_D=8~A$	Ch-1	-	0.0077	0.0120		
	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	Ch-2	-	0.0040	0.0052		
06	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	Ch-1	-	54	-	s	
915	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	Ch-2	-	52	-	Ű	
		•		1	1		
Cicc		Ch-1	-	1000	-		
0155		Ch-2	-	2425	-		
Coss	Channel-1	Ch-1	-	280	-	pF	
0000	$V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz$	Ch-2	-	730	-		
Cree	Channel-2 Vpg = 15 V, Vpg = 0 V, f = 1 MHz	Ch-1	-	34	-		
- 133	$v_{\rm DS} = 13 v$; $v_{\rm GS} = 0 v$; $i = 1 MHz$	Ch-2	-	65	-		
		Ch-1	-	0.034	0.068		
		-	-	0.027	0.054		
	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A	-	-	14.3	21.5		
Q _a			-	34	51		
9		Ch-1	-	6.9	10.5		
	Channel-1		-	15.4	23.1		
Q _{qs}			-	2.8	-	nC	
95	Channel-2 Vec = 15 V, Vec = 4.5 V, Je = 10.4	Ch-2	-	5.8	-		
Q _{ad}	$v_{DS} = 10 v, v_{GS} = 4.0 v, I_D = 10 A$	Ch-1	-	1.6	-		
~yu			-		-		
Qoss	$V_{DS} = 15 \text{ V}. \text{ V}_{CS} = 0 \text{ V}$	Ch-1	-	7.8	-		
		Ch-2	-	20	-		
Ra	f = 1 MHz	Ch-1	0.4	1.6	3.2	Ω	
	R _{DS(on)} Gfs C _{iss} C _{oss} C _{rss} Q _g Q _g Q _g Q _{gd} Q _{gs} R _g	$\begin{array}{c} \label{eq:RDS(on)} & \begin{matrix} V_{GS} = 10 \ V, \ I_{D} = 19 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_{D} = 8 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_{D} = 15 \ A \\ \hline V_{DS} = 10 \ V, \ I_{D} = 10 \ A \\ \hline V_{DS} = 10 \ V, \ I_{D} = 10 \ A \\ \hline V_{DS} = 10 \ V, \ I_{D} = 10 \ A \\ \hline V_{DS} = 10 \ V, \ I_{D} = 10 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & \begin{matrix} Channel-1 \\ V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline Q_{g} & \begin{matrix} V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_{D} = 10 \ A \\ \hline Q_{gs} & \begin{matrix} Channel-1 \\ V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_{D} = 10 \ A \\ \hline Q_{gd} & \begin{matrix} Channel-2 \\ V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_{D} = 10 \ A \\ \hline Q_{oss} & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V \\ \hline \end{array}$	$ \begin{array}{c} \mbox{$P_{DS}(on)$} & \begin{tabular}{ c c } \hline V_{GS} = 10 \ V, \ I_D = 19 \ A & \ Ch-2 \\ \hline V_{GS} = 4.5 \ V, \ I_D = 8 \ A & \ Ch-1 \\ \hline V_{GS} = 4.5 \ V, \ I_D = 15 \ A & \ Ch-2 \\ \hline V_{GS} = 4.5 \ V, \ I_D = 10 \ A & \ Ch-2 \\ \hline \\ \hline \mbox{$Q_{S} = 10 \ V, \ I_D = 10 \ A & \ Ch-1 \\ \hline V_{DS} = 10 \ V, \ I_D = 10 \ A & \ Ch-2 \\ \hline \hline \end{tabular} \\ \hline \end{tabular} \\$	$ \begin{array}{c ccccc} & V_{GS} = 10 \ V, \ I_{D} = 19 \ A & Ch-2 & - & \\ \hline V_{GS} = 4.5 \ V, \ I_{D} = 8 \ A & Ch-1 & - & \\ \hline V_{GS} = 4.5 \ V, \ I_{D} = 15 \ A & Ch-2 & - & \\ \hline V_{DS} = 10 \ V, \ I_{D} = 10 \ A & Ch-1 & - & \\ \hline V_{DS} = 10 \ V, \ I_{D} = 10 \ A & Ch-2 & - & \\ \hline V_{DS} = 10 \ V, \ I_{D} = 10 \ A & Ch-2 & - & \\ \hline \\$	$ \begin{array}{c c c c c c } & V_{GS} = 10 \ V, \ I_D = 19 \ A & Ch-2 & - & 0.0028 \\ \hline V_{GS} = 4.5 \ V, \ I_D = 8 \ A & Ch-1 & - & 0.0077 \\ \hline V_{GS} = 4.5 \ V, \ I_D = 15 \ A & Ch-2 & - & 0.0040 \\ \hline V_{DS} = 10 \ V, \ I_D = 10 \ A & Ch-1 & - & 54 \\ \hline V_{DS} = 10 \ V, \ I_D = 10 \ A & Ch-2 & - & 52 \\ \hline V_{DS} = 10 \ V, \ I_D = 10 \ A & Ch-2 & - & 52 \\ \hline V_{DS} = 10 \ V, \ I_D = 10 \ A & Ch-2 & - & 52 \\ \hline Ch-1 & - & 2425 \\ \hline Ch-1 & - & 280 \\ \hline Ch-2 & - & 2425 \\ \hline Ch-1 & - & 280 \\ \hline Ch-2 & - & 730 \\ \hline Ch-2 & - & 730 \\ \hline Ch-2 & - & 730 \\ \hline Ch-2 & - & 65 \\ \hline Ch-1 & - & 0.034 \\ \hline Ch-2 & - & 65 \\ \hline Ch-1 & - & 0.034 \\ \hline Ch-2 & - & 65 \\ \hline Ch-1 & - & 0.034 \\ \hline Ch-2 & - & 0.027 \\ \hline Ch-2 & - & 0.027 \\ \hline Ch-2 & - & 0.027 \\ \hline Ch-2 & - & 34 \\ \hline Ch-2 & - & 15.4 \\ \hline Ch-2 & - & 15.4 \\ \hline Ch-2 & - & 15.4 \\ \hline Ch-2 & - & 5.8 \\ \hline Ch-1 & - & 1.6 \\ \hline Ch-2 & - & 5.8 \\ \hline Ch-1 & - & 1.6 \\ \hline Ch-2 & - & 2.6 \\ \hline Ch-2 & - & & 2.6 \\ \hline Ch-2 & - & & 2.6 \\ \hline Ch-2 & - & & & 2.6 \\ $	$ \begin{array}{c c c c c c c c } \hline \begin{tabular}{ c c c c } \hline $V_{GS} = 10 \ V, \ I_D = 19 \ A & Ch-2 & - & 0.0028 & 0.0041 \\ \hline $V_{GS} = 4.5 \ V, \ I_D = 16 \ A & Ch-1 & - & 0.0077 & 0.0120 \\ \hline $V_{GS} = 4.5 \ V, \ I_D = 15 \ A & Ch-2 & - & 0.0040 & 0.0052 \\ \hline $V_{DS} = 10 \ V, \ I_D = 10 \ A & Ch-1 & - & 54 & - \\ \hline $V_{DS} = 10 \ V, \ I_D = 10 \ A & Ch-2 & - & 52 & - \\ \hline $V_{DS} = 10 \ V, \ I_D = 10 \ A & Ch-2 & - & 52 & - \\ \hline $V_{DS} = 10 \ V, \ I_D = 10 \ A & Ch-2 & - & 52 & - \\ \hline $V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline $C_{rss} $ \begin{tabular}{ c c c c } \hline $Ch-1 & - & 1000 & - & \\ \hline $Ch-2 & - & 2425 & - & \\ \hline $Ch-1 & - & 2425 & - & \\ \hline $Ch-1 & - & 280 & - & \\ \hline $Ch-2 & - & 2425 & - & \\ \hline $Ch-1 & - & 280 & - & \\ \hline $Ch-2 & - & 655 & - & \\ \hline $Ch-2 & - & 655 & - & \\ \hline $Ch-2 & - & 655 & - & \\ \hline $Ch-2 & - & 655 & - & \\ \hline $Ch-2 & - & 655 & - & \\ \hline $Ch-2 & - & 655 & - & \\ \hline $Ch-2 & - & 655 & - & \\ \hline $Ch-2 & - & 655 & - & \\ \hline $Ch-2 & - & 0.027 & 0.054 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-1 & - & 0.69 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 & - & 0.02 & 0 \\ \hline $Ch-2 &$	

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SiZ988DT

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Dynamic ^a					I.	1	
	+		Ch-1	-	15	30	
Turn-On Delay Time	t _{d(on)}		Ch-2	-	20	40	
Rise Time	+	Channel-1 V _{DD} = 15 V, R _L = 1.5 Ω	Ch-1	-	10	20	
	tr	$I_D \cong 10$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$	Ch-2	-	15	30	
	+	Channel-2	Ch-1	-	15	30	
Turn-Off Delay Time	t _{d(off)}	V_{DD} = 15 V, R _L = 1.5 I _D ≅ 10 A, V _{GEN} = 4.5 V, R _g = 1 Ω	Ch-2	-	25	50	
Fall Time	+	D = 10000, 0 Gen = 1000, 100 g = 122	Ch-1	-	7	15	
Fair Time	t _f		Ch-2	-	10	20	
Turn-On Delay Time	+		Ch-1	-	10	20	ns
Turn-On Delay Time	t _{d(on)}		Ch-2	-	10	20	
		Channel-1 V _{DD} = 15 V, R _L = 1.5 Ω	Ch-1	-	10	20	
Rise Time	t _r	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω	Ch-2	-	10	20	
		Channel-2	Ch-1	-	15	30	
Turn-Off Delay Time	t _{d(off)}	V_{DD} = 15 V, R_L = 1.5 Ω $I_D \cong$ 10 A, V_{GEN} = 10 V, R_q = 1 Ω	Ch-2	-	27	50	
		$D = 107.0$ $G_{EN} = 100.0$, $10 = 122$	Ch-1	-	5	10	
Fall Time	t _f		Ch-2	-	10	20	
Drain-Source Body Diode Characterist	ics	-					
Continuous Source-Drain Diode Current	Is	T _C = 25 °C	Ch-1	-	-	16.8	
Continuous Source-Drain Diode Current	15	16 - 23 0	Ch-2	-	-	33.6	A
Pulse Diode Forward Current (t = 100 µs)	I _{SM}		Ch-1	-	-	70	~
The block forward burrent $(t - 100 \ \mu s)$	ISM		Ch-2	-	-	140	
Body Diode Voltage	V _{SD}	$I_{\rm S} = 5 \; {\rm A}, \; {\rm V}_{\rm GS} = 0 \; {\rm V}$	Ch-1	-	0.77	1.2	v
Body Blode Voltage	▼SD	$I_{\rm S} = 10$ A, $V_{\rm GS} = 0$ V	Ch-2	-	0.8	1.2	v
Body Diode Reverse Recovery Time	t _{rr}		Ch-1	-	19	35	ns
Body Diode Neverse Necovery Time	۲r		Ch-2	-	31	62	115
Body Diode Reverse Recovery Charge	Q _{rr}	Channel-1	Ch-1	-	7	14	nC
Body Blode Heverse Hecovery charge	۲r	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$	Ch-2	-	19	40	
Reverse Recovery Fall Time	t _a	Channel-2	Ch-1	-	10	-	
		$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 \text{ °C}$	Ch-2	-	14	-	ns
Poverse Pecovery Pice Time	+		Ch-1	-	9	-	115
Reverse Recovery Rise Time	t _b		Ch-2	-	17	-	

Notes

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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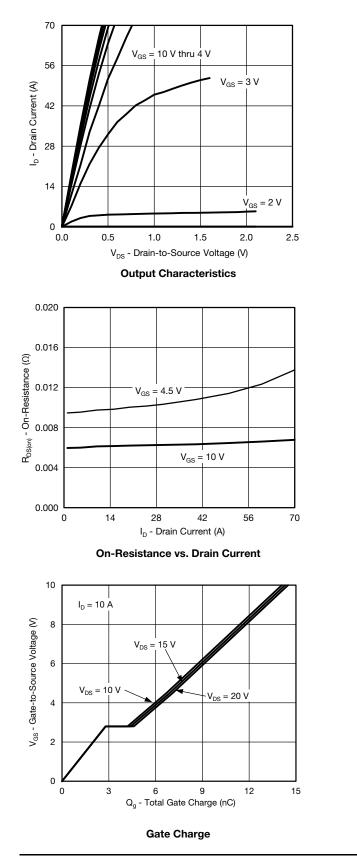


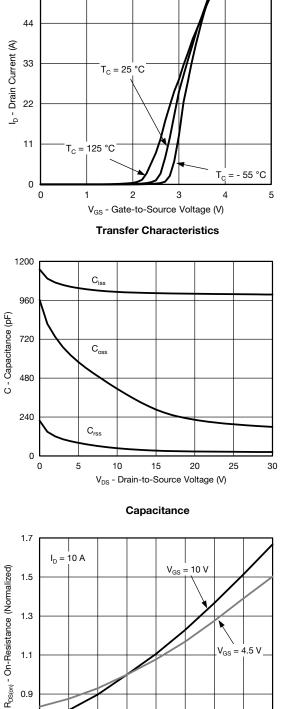
SiZ988DT

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CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

55





V_{GS} = 4.5 V 1.1 0.9 0.7 - 50 - 25 0 25 50 75 100 125 150 T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

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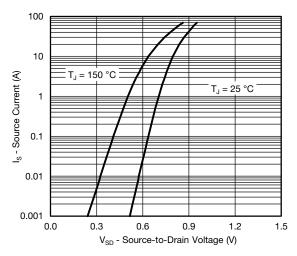
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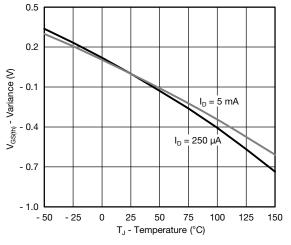
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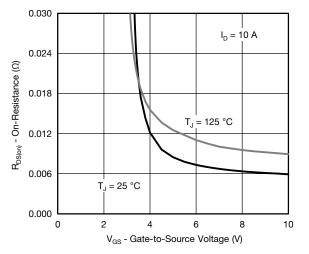
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



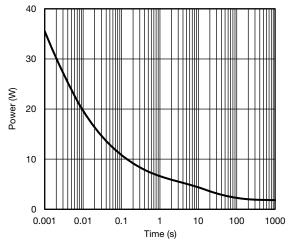
Source-Drain Diode Forward Voltage



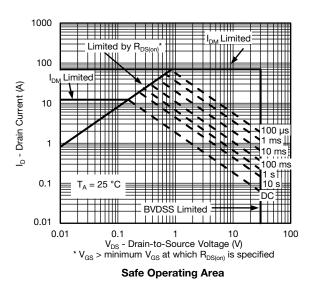




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



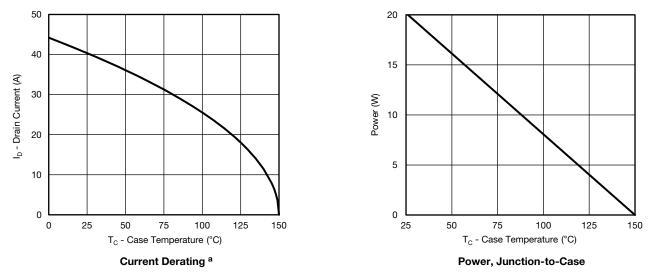
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CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



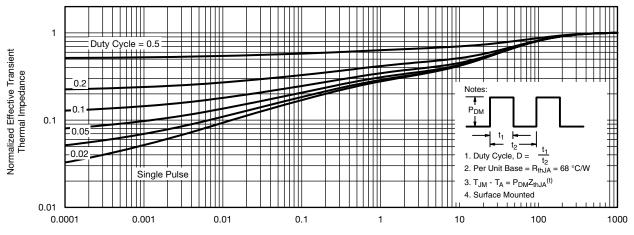
Note

a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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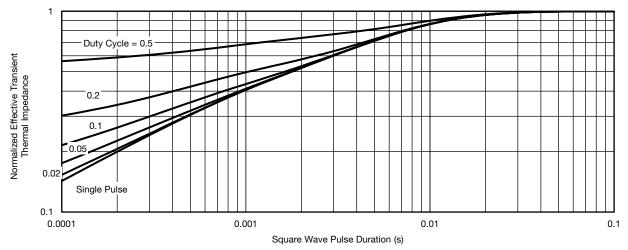


CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

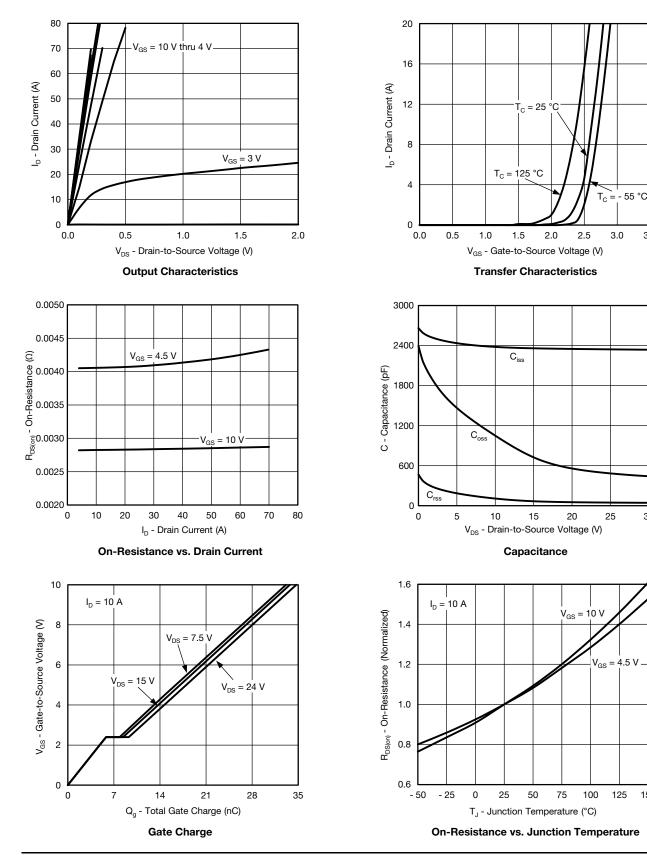


3.5

30

Vishay Siliconix

CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



S15-2567-Rev. A, 02-Nov-15

8

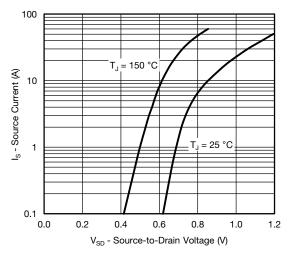
Document Number: 66937

150

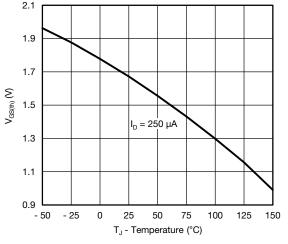
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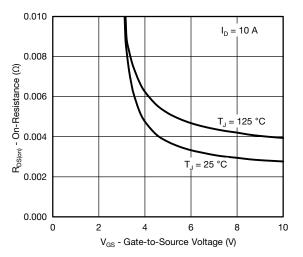
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



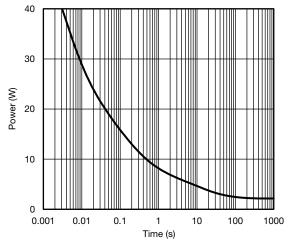
Source-Drain Diode Forward Voltage



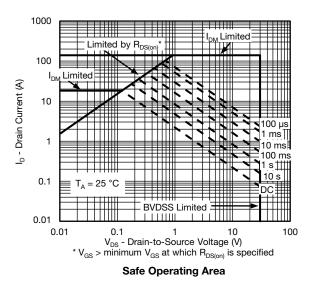




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



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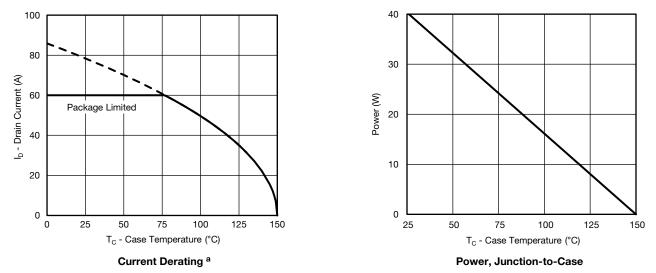
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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



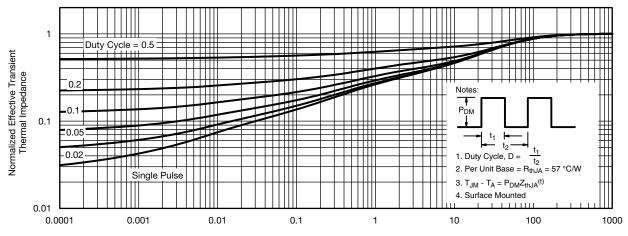
Note

a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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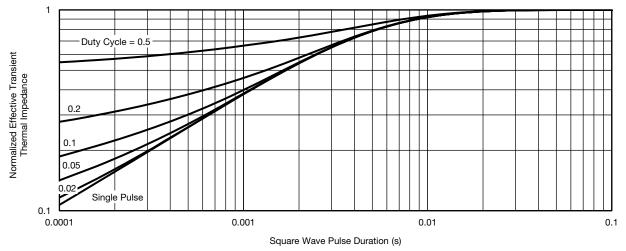


CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient



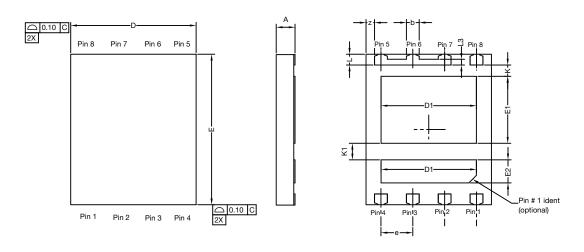
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?66937.

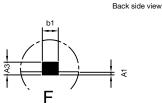
11

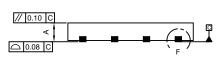


PowerPAIR[®] 6 x 5 Case Outline



Top side view





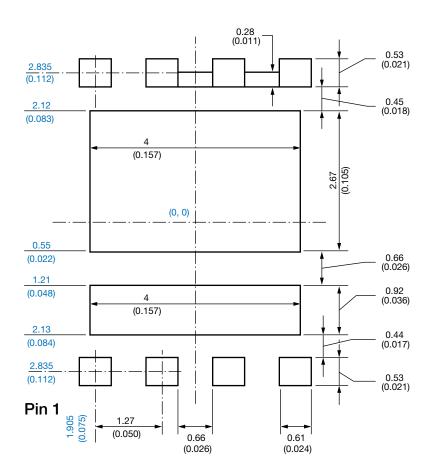
		MILLIMETERS		INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.70	0.75	0.80	0.028	0.030	0.032		
A1	0.00	-	0.10	0.000	-	0.004		
A3	0.15	0.20	0.25	0.006	0.007	0.009		
b	0.43	0.51	0.61	0.017	0.020	0.024		
b1	0.25 BSC 0.010 BSC							
D	4.90	5.00	5.10	0.192 0.196 0.20				
D1	3.75	3.80	3.85	0.148	0.150	0.152		
E	5.90	6.00	6.10	0.232	0.236	0.240		
E1 Option AA (for W/B)	2.62	2.67	2.72	0.103	0.105	0.107		
E1 Option AB (for BWL)	2.42	2.47	2.52	0.095	0.095 0.097 0.09			
E2	0.87	0.92	0.97	0.034 0.036 0.038				
е	1.27 BSC 0.050 BSC							
K Option AA (for W/B)		0.45 typ.		0.018 typ.				
K Option AB (for BWL)		0.65 typ.		0.025 typ.				
K1		0.66 typ.		0.025 typ.				
L	0.33	0.43	0.53	0.013	0.017	0.020		
L3		0.23 BSC		0.009 BSC				
Z	0.34 BSC 0.013 BSC							

Revision: 22-Dec-14

Document Number: 63656



Recommended Minimum PAD for PowerPAIR[®] 6 x 5



Dimensions in millimeters (inch)

Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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